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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I <sup>2</sup> C, LINbus, SIO, SSU, UART/USART
Peripherals	LED, POR, Voltage Detect, WDT
Number of I/O	25
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21272sdfp-v2

Email: info@E-XFL.COM

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#### 1.3 **Block Diagram**

Figure 1.1 shows a Block Diagram.



Figure 1.1 **Block Diagram** 



#### 1.4 **Product Information**

Table 1.3 lists the Product Information for R8C/26 Group and Table 1.4 lists the Product Information for R8C/27 Group.

Table 1.3 Product In	Cur	rent of Sep. 2008			
Part No.	ROM Capacity	RAM Capacity	Package Type	R	emarks
R5F21262SNFP	8 Kbytes	512 bytes	PLQP0032GB-A	N version	
R5F21264SNFP	16 Kbytes	1 Kbyte	PLQP0032GB-A		
R5F21265SNFP	24 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21266SNFP	32 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21262SDFP	8 Kbytes	512 bytes	PLQP0032GB-A	D version	
R5F21264SDFP	16 Kbytes	1 Kbyte	PLQP0032GB-A		
R5F21265SDFP	24 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21266SDFP	32 Kbytes	1.5 Kbytes	PLQP0032GB-A	_	
R5F21264JFP	16 Kbytes	1 Kbyte	PLQP0032GB-A	J version	
R5F21266JFP	32 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21264KFP	16 Kbytes	1 Kbyte	PLQP0032GB-A	K version	
R5F21266KFP	32 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21262SNXXXFP	8 Kbytes	512 bytes	PLQP0032GB-A	N version	Factory
R5F21264SNXXXFP	16 Kbytes	1 Kbyte	PLQP0032GB-A		programming
R5F21265SNXXXFP	24 Kbytes	1.5 Kbytes	PLQP0032GB-A		product <sup>(1)</sup>
R5F21266SNXXXFP	32 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21262SDXXXFP	8 Kbytes	512 bytes	PLQP0032GB-A	D version	
R5F21264SDXXXFP	16 Kbytes	1 Kbyte	PLQP0032GB-A		
R5F21265SDXXXFP	24 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21266SDXXXFP	32 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21264JXXXFP	16 Kbytes	1 Kbyte	PLQP0032GB-A	J version	
R5F21266JXXXFP	32 Kbytes	1.5 Kbytes	PLQP0032GB-A		
R5F21264KXXXFP	16 Kbytes	1 Kbyte	PLQP0032GB-A	K version	
R5F21266KXXXFP	32 Kbytes	1.5 Kbytes	PLQP0032GB-A		

#### **Product Information for R8C/26 Group** Table 1.3

NOTE:

1. The user ROM is programmed before shipment.



### 1.6 Pin Functions

Table 1.5 lists Pin Functions.

#### Table 1.5Pin Functions

Power supply input         VCC, VSS         I         Apply 2.2 to 5.5 V (J, K version are 2.7 to 5.5 V) to the VCC pin. Apply 0 V to the VSS pin.           Analog power supply input         AVCC, AVSS         I         Power supply for the A/D converter.           Supply input         RESET         I         Input 1: on this pin resets the MCU.           MODE         MODE         I connect at capacitor between AVCC and AVSS.           Reset input         RESET         I         Input 1: on this pin resets the MCU.           MODE         MODE         Connect at is pin to VCC via a resistor.           XIN clock koutput         XOUT         O         These pins are provided for XIN clock generation circuit I/O.           No Dersion         Connect a crystal oscillator between the XCIN and XCOUT pin. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.           NL D version         XCOUT         O         Time requipt input pins           Torregative provided for XIN clock generation circuit I/O.         Connect a crystal oscillator between the XCIN and XCOUT pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.           NT interrupt input         INTO, INTT, INTT3         I         INT interrupt input pins           Time regative provided for XIN code generation circuit I/O.         Connect a crystal oxiput pin           Timer RA         TRAIO         O	Туре	Symbol	I/O Type	Description
Analog power supply input         AVCC, AVSS         I         Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.           Reset input         RESET         I         Input "L" on this pin resets the MCU.           MODE         MODE         I         Connect this pin to VCC via a resistor.           XIN clock input         XIN         I         These pins are provided for XIN clock generation circuit I/O. Connect a carpitor resonator or a crystal oscillator between the XIN and XOUT pin s. To use an external clock, input it to the XIN clock output (N, D version)         XCIN         I         These pins are provided for XIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.           INT interrupt input         INTO, INTT, INT3         I         INT interrupt input pins           Timer RA         TRAO         O         Timer RA i/O pin           Timer RB         TRBO         O         Timer RA or uput pin           Timer RB         TRBO         O         Timer RB output pin           Timer RE         TRECIA, TRCIOB, I/O         Staring output-compare output / input-capture input / PWM / PWM2 output pins           Timer RE         TREO         O         Timer RE output pin           Timer RE         SCL         I/O         Clock I/O pin           Text C	Power supply input	VCC, VSS	I	Apply 2.2 to 5.5 V (J, K version are 2.7 to 5.5 V) to the VCC pin. Apply 0 V to the VSS pin.
Reset inputRESETIInput "L" on this pin resets the MCU.MODEMODEIConnect this pin to VCC via a resistor.XIN clock inputXINIThese pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins. To use an external clock, input it to the XIN pin and leave the XOUT pino. To use an external clock, input it to the XIN pin and leave the XOUT pino. To use an external clock, input it to the XCIN pin and leave the XCOUT pino. To use an external clock, input it to the XCIN pin and leave the XCOUT pino. To use an external clock, input it to the XCIN pin and leave the XCOUT pino. To use an external clock, input it to the XCIN pin and leave the XCOUT pino.XCIN clock output (N, D version)XCOUTOTimer RA coUD pin Open.XCIN clock output (N, D version)INTO, INT1, INT3IINT interrupt input pinsKey input interruptKIO to KI3IKey input interrupt input pinsTimer RA Timer RBTRAOOTimer RA output pinTimer RBTRBOOTimer RA output pinTimer RBTRBOOTimer RB output pinTimer RETRCOLKIExternal clock input pinTimer RETREOOTimer RE output pinTimer RETREOOTimer RE output pinTimer RECLO, CLK1I/OClock I/O pinSetal interfaceSCLI/OClock I/O pinSoCI/OD ata I/O pinSiSII/OD ata I/O pinSoCI/OChip-select signal I/O pin <td>Analog power supply input</td> <td>AVCC, AVSS</td> <td>I</td> <td>Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.</td>	Analog power supply input	AVCC, AVSS	I	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
MODE         MODE         I         Connect this pin to VCC via a resistor.           XIN clock input         XIN         I         These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins. To use an external clock, input it to the XIN pin and leave the XOUT pin open.           XCIN clock output         XCIN         I         These pins are provided for XIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.           XCIN clock output         XCOUT         O         Connect a crystal oscillator between the XCIN and XCOUT pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.           XIN rin interrupt input Ney input interrupt         INTO, INTT, INT3         I         INT interrupt input pins           Timer RA         TRAO         O         Timer RA output pin           Timer RB         TRBO         O         Timer RB to pin 0           Timer RE         TRCCLK         I         External clock input pin           TRCICA, TRCIOB, TRCIOC, TRCIOB         I/O         Sharing output-compare output / input-capture input / PWM / PWM2 output pins           Timer RE         TREO         O         Timer RE output pin           Timer RE         SCL         I/O         Clock I/O pin           Serial	Reset input	RESET	I	Input "L" on this pin resets the MCU.
XIN clock input     XIN     I     These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins. To use an external clock, input it to the XIN and XOUT pins. To use an external clock, input it to the XIN and XOUT pins. To use an external clock, input it to the XIN and XOUT pins. To use an external clock, input it to the XIN pin and leave the XOUT pin open.       XCIN clock output XCIN clock output (N, D version)     XCOUT     O     These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.       INT interrupt input (N, D version)     INTO, INTT, INT3     I     INT interrupt input pins       Key input interrupt     KiO to Ki3     I     Key input interrupt input pins       Timer RA     TRAIO     O     Timer RA output pin       Timer RB     TRBO     O     Timer RB output pin       Timer RE     TRCCLK     I     External clock input pin       Timer RE     TRCO, TRCIOB     I/O     Sharing output-compare output / input-capture input / PWM / PWM2 output pins       Timer RE     TREO     O     Timer RE output pin       Timer RE     TREO     O     Timer RE output pin       Timer RE     SCL     I/O     Clock I/O pin       SCL     I/O     Data I/O pin     SCS       SCR     I/O     Data I/	MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN clock output     XOUT     O     XIN pin and XOUT pin 3. to use an external clock, input it to the XIN pin and leave the XOUT pin open.       XCIN clock input     XCIN     I     These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT pins. To use an external clock, input it to the XCIN pin and leave the XCUT pin open.       INT interrupt input     INTT, INT3     I     INT interrupt input pins       Key input interrupt     KIO to KI3     I     Key input interrupt input pins       Timer RA     TRAO     O     Timer RA l/O pin       Timer RB     TRBO     O     Timer RB output pin       Timer RC     TRCCLK     I     External tigger input pin       Timer RE     TRCO, TRCIOB     I/O     Sharing output-compare output / input-capture input / PWM / PWM2 output pins       Timer RE     TREO     O     Timer RE output pin       Timer RE     TREO     O     Timer RE output pins       Timer RE     TREO     O     Timer RE output pins       Timer RE     TREO     O     Timer RE output pins       Timer RE     REC     I/O     Sharing output-compare output / input-capture input / PWM / PWM2 output pins       Serial interface     CLK0, CLK1     I/O     Clock I/O pin       SOD     I/O     Transmit data output pin       TXD0, TXD1 <td< td=""><td>XIN clock input</td><td>XIN</td><td>I</td><td>These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the</td></td<>	XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the
XCIN clock input (N, D version)XCINIThese pins are provided for XCIN clock generation circult /O. Connect a crystal oscillator between the XCIN and XCOUT pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.INT interrupt inputINTO, INT1, INT3IINT interrupt input pinsKey input interruptKI0 to KI3IKey input interrupt input pinsTimer RATRAIOOTimer RA output pinTimer RBTRBOOTimer RB output pinTimer RCTRCCLKIExternal trigger input pinTimer RETREOOTimer RE output pinSerial interfaceCLK0, CLK1I/OSharing output-compare output / input-capture input / PWM/ PVMZ output pinsZCDu synchronous serial I/O with chip selectSSII/OClock I/O pinReference voltage inputSSII/OData I/O pinReference voltage riputVEEFIReference voltage input pin to A/D converterI/O portPO_0 to PO_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P3_3 to P3_7, P3_3 to P4_5, P5_4I/OClock I/O pinInput-portP4 2, P4 6, P4 7IInput-ontwordsInput-ontwordsInput portP4 2, P4 6, P4 7IInput-ontwords	XIN clock output	XOUT	0	XIN and XOOT pins. To use an external clock, input it to the XIN pin and leave the XOUT pin open.
XCIN clock output (N, D version)         XCOUT         O         pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.           INT interrupt input         INTO, INTO, INTO, INTO         I         INT interrupt input pins           Key input interrupt         KI0 to KI3         I         Key input interrupt input pins           Timer RA         TRAO         O         Timer RA output pin           Timer RB         TRBO         O         Timer RA output pin           Timer RC         TRCCLK         I         External clock input pin           Timer RC         TRCCLK         I         External trigger input pin           Timer RE         TRCO, TRCIOB,         I/O         Sharing output-compare output / input-capture input / PWM / PVM2 output pins           Timer RE         TREO         O         Timer RE output pin           Timer RE         TREO         O         Timer RE output pin           Timer RE         TREO         O         Timer RE output pin           TXD0, TXD1         O         Transmit data output pin           TXD0, TXD1         O         Transmit data output pin           TXD0, TXD1         O         Transmit data output pin           SCS         I/O         Clock I/O pin           Seck	XCIN clock input (N, D version)	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT
INT interrupt input         INT0, INT1, INT3         I         INT interrupt input pins           Key input interrupt         KI0 to KI3         I         Key input interrupt input pins           Timer RA         TRAO         O         Timer RA output pin           Timer RB         TRBO         O         Timer RA U/O pin           Timer RB         TRBO         O         Timer RB output pin           Timer RB         TRCLK         I         External toger input pin           TRCIOA, TRCIOB, TRCIOC, TRCIOD         IVO         Sharing output-compare output / input-capture input / PWM / PWM2 output pins           Timer RE         TREO         O         Timer RE culture pin           Serial interface         CLK0, CLK1         I/O         Clock I/O pin           RXD0, RXD1         I         Receive data input pin           TXD0, TXD1         O         Transmit data output pin           TXD0, TXD1         O         Transmit data output pin           SCL         I/O         Clock I/O pin           Select         SSI         I/O         Data I/O pin           SSCK         I/O         Clock I/O pin         SSO           A/D converter         AN0 to AN11         I         Analog input pins to A/D converter	XCIN clock output (N, D version)	XCOUT	0	leave the XCOUT pin open.
Key input interruptKl0 to Kl3IKey input interrupt input pinsTimer RATRAOOTimer RA output pinTimer RBTRBOOTimer RA output pinTimer RBTRBOOTimer RB output pinTimer RCTRCCLKIExternal clock input pinTimer RETRCOA, TRCIOB, TRCIOC, TRCIODI/OSharing output-compare output / input-capture input / PWM / PWM2 output pinsTimer RETREOOTimer RE output pinSerial interfaceCLK0, CLK1I/OClock I/O pinRZD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pin12C bus interfaceSCLI/OClock I/O pinSerial I/O with chip selectSSII/OData I/O pinSSCKI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually.Input portP4_2, P4_6, P4_7IInput-only ports	INT interrupt input	INTO, INT1, INT3	I	INT interrupt input pins
Timer RA         TRAO         O         Timer RA output pin           Timer RB         TRBO         O         Timer RB output pin           Timer RC         TRCCLK         I         External clock input pin           TRCTRG         I         External trigger input pin           TRCIOA, TRCIOB, TRCIOC, TRCIOD         I/O         Sharing output-compare output / input-capture input / PWM / PWM/ output pins           Timer RE         TREO         O         Timer RE output pin           Serial interface         CLK0, CLK1         I/O         Clock I/O pin           RXD0, RXD1         I         Receive data input pin           TXD0, TXD1         O         Transmit data output pin           I²C bus interface         SCL         I/O         Clock I/O pin           Select         SSI         I/O         Data I/O pin           Select         SSO         I/O         Data I/O pin           Reference voltage         VREF         I         Reference voltage input pin to A/D converter           I/O po	Key input interrupt	KI0 to KI3	I	Key input interrupt input pins
TRAIOI/OTimer RA I/O pinTimer RBTRBOOTimer RB output pinTimer RCTRCCLKIExternal clock input pinTRCTRGIExternal trigger input pinTRCIOA, TRCIOB, TRCIOC, TRCIODI/OSharing output-compare output / input-capture input / PWM / PWM2 output pinsTimer RETREOOTimer RE output pinSerial interfaceCLK0, CLK1I/OClock I/O pinRZD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pinI²C bus interfaceSCLI/OClock I/O pinSerial I/O with chip selectSSII/OData I/O pinClock synchronous serial I/O with chip selectSSII/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_7, P4_5, P3_7, P4_5, P4_5, P3_54I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually.Input portP4_2, P4_6, P4_7IInput-only ports	Timer RA	TRAO	0	Timer RA output pin
Timer RBTRBOOTimer RB output pinTimer RCTRCCLKIExternal clock input pinTRCTRGIExternal trigger input pinTRCIOA, TRCIOB, TRCIOC, TRCIODI/OSharing output-compare output / input-capture input / PWM / PWM2 output pinsTimer RETREOOTimer RE output pinSerial interfaceCLK0, CLK1I/OClock I/O pinRZD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pinI²C bus interfaceSCLI/OClock I/O pinSerial I/O with chip selectSSII/OData I/O pinSCSI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_7, P3_3 to P3_7, P4_5, P4_5, P3_54I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually.Input portP4_2, P4, 6, P4_7IInput-only ports		TRAIO	I/O	Timer RA I/O pin
Timer RCTRCCLKIExternal clock input pinTRCTRGIExternal trigger input pinTRCIOA, TRCIOB, TRCIOC, TRCIODI/OSharing output-compare output / input-capture input / PWM / PWM2 output pinsTimer RETREOOTimer RE output pinSerial interfaceCLK0, CLK1I/OClock I/O pinRXD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pin12C bus interfaceSCLI/OClock I/O pinSerial I/O with chip selectSSII/OData I/O pinClock synchronous serial I/O with chip selectSSII/OClock I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P4_5, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually.Input portP4_2, P4_6, P4_7IInput-only ports	Timer RB	TRBO	0	Timer RB output pin
TRCTRGIExternal trigger input pinTRCIOA, TRCIOB, TRCIOC, TRCIODI/OSharing output-compare output / input-capture input / PWM / PWM2 output pinsTimer RETREOOTimer RE output pinSerial interfaceCLK0, CLK1I/OClock I/O pinRXD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pin12C bus interfaceSCLI/OClock I/O pinSerial I/O with chip selectSSII/OData I/O pinClock synchronous serial I/O with chip selectSSII/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P1_0 to P1_7,	Timer RC	TRCCLK	I	External clock input pin
TRCIOA, TRCIOB, TRCIOC, TRCIODI/OSharing output-compare output / input-capture input / PWM / PWM2 output pinsTimer RETREOOTimer RE output pinSerial interfaceCLK0, CLK1I/OClock I/O pinRXD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pin12C bus interfaceSCLI/OClock I/O pinSolaV/OData I/O pinClock synchronous serial I/O with chip selectSSII/OChip-select signal I/O pinSSOI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P1_0 to P1_7 also function as LED drive ports (N, D version).Input portP4_2, P4_6, P4_7IInput-only ports		TRCTRG	I	External trigger input pin
Timer RETREOOTimer RE output pinSerial interfaceCLK0, CLK1I/OClock I/O pinRXD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pinI²C bus interfaceSCLI/OClock I/O pinSDAI/OData I/O pinClock synchronous serial I/O with chip selectSSII/OData I/O pinSSCKI/OClock I/O pinSSOI/OClock I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P4_5, P5_3, P5_4I/OCMOS I/O portsInput portP4_2, P4 6, P4_7IInput-only ports		TRCIOA, TRCIOB, TRCIOC, TRCIOD	I/O	Sharing output-compare output / input-capture input / PWM / PWM2 output pins
Serial interfaceCLK0, CLK1I/OClock I/O pinRXD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pinI²C bus interfaceSCLI/OClock I/O pinSDAI/OData I/O pinClock synchronous serial I/O with chip selectSSII/OData I/O pinSSCKI/OClock I/O pinSSOI/OClock I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterI/O portP0_0 to P0_7, 	Timer RE	TREO	0	Timer RE output pin
RXD0, RXD1IReceive data input pinTXD0, TXD1OTransmit data output pinI²C bus interfaceSCLI/OClock I/O pinClock synchronous serial I/O with chip selectSSII/OData I/O pinClock synchronous serial I/O with chip selectSSII/OChip-select signal I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_7, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P1_0 to P1_7 also function as LED drive ports (N, D version).Input portP4 2, P4 6, P4 7IInput-only ports	Serial interface	CLK0, CLK1	I/O	Clock I/O pin
TXD0, TXD1OTransmit data output pinI2C bus interfaceSCLI/OClock I/O pinSDAI/OData I/O pinClock synchronous serial I/O with chip selectSSII/OData I/O pinSCSI/OChip-select signal I/O pinSSOI/OClock I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_7, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually.Input portP4_2, P4_6, P4_7IInput-only ports		RXD0, RXD1	I	Receive data input pin
I2C bus interfaceSCLI/OClock I/O pinSDAI/OData I/O pinClock synchronous serial I/O with chip selectSSII/OData I/O pinSCSI/OChip-select signal I/O pinSCKI/OClock I/O pinSSOI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P4_5, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually.Input portP4_2, P4_6, P4_7IInput-only ports		TXD0, TXD1	0	Transmit data output pin
SDAI/OData I/O pinClock synchronous serial I/O with chip selectSSII/OData I/O pinSCSI/OChip-select signal I/O pinSCKI/OClock I/O pinSSOI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually.Input portP4_2, P4_6, P4_7IInput-only ports	I <sup>2</sup> C bus interface	SCL	I/O	Clock I/O pin
Clock synchronous serial I/O with chip selectSSII/OData I/O pinSCKI/OChip-select signal I/O pinSSCKI/OClock I/O pinSSOI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P1_0 to P1_7 also function as LED drive ports (N, D version).Input portP4_2, P4_6, P4_7IInput-only ports		SDA	I/O	Data I/O pin
serial I/O with chip selectSCSI/OChip-select signal I/O pinSSCKI/OClock I/O pinSSOI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. P1_0 to P1_7 also function as LED drive ports (N, D version).Input portP4_2, P4_6, P4_7IInput-only ports	Clock synchronous	SSI	I/O	Data I/O pin
SelectSSCKI/OClock I/O pinSSOI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P4_5, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P1_0 to P1_7 also function as LED drive ports (N, D version).Input portP4_2, P4_6, P4_7IInput-only ports	serial I/O with chip	SCS	I/O	Chip-select signal I/O pin
SSOI/OData I/O pinReference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. P1_0 to P1_7 allowing each pin in the port to be directed for input or output individually. P1_0 to P1_7 also function as LED drive ports (N, D version).Input portP4_2, P4_6, P4_7IInput-only ports	Select	SSCK	I/O	Clock I/O pin
Reference voltage inputVREFIReference voltage input pin to A/D converterA/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. P1_0 to P1_7 also function as LED drive ports (N, D version).Input portP4_2, P4_6, P4_7IInput-only ports		SSO	I/O	Data I/O pin
A/D converterAN0 to AN11IAnalog input pins to A/D converterI/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P1_0 to P1_7 also function as LED drive ports (N, D version).Input portP4_2, P4_6, P4_7IInput-only ports	Reference voltage input	VREF	I	Reference voltage input pin to A/D converter
I/O portP0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P4_5, P5_3, P5_4I/OCMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually.Input portP4_2, P4_6, P4_7IInput-only ports	A/D converter	AN0 to AN11	I	Analog input pins to A/D converter
Input port P4_2, P4_6, P4_7 I Input-only ports	I/O port	P0_0 to P0_7, P1_0 to P1_7, P3_1, P3_3 to P3_7, P4_5, P5_3, P5_4	I/O	CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P1 0 to P1 7 also function as LED drive ports (N. D version)
	Input port	P4_2, P4_6, P4_7	I	Input-only ports

I: Input O: Output I/O: Input and output

## 2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.



## 3.2 R8C/27 Group

Figure 3.2 is a Memory Map of R8C/27 Group. The R8C/27 group has 1 Mbyte of address space from addresses 00000h to FFFFFh.

The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 16-Kbyte internal ROM area is allocated addresses 0C000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM area is allocated higher addresses, beginning with address 00400h. For example, a 1-Kbyte internal RAM is allocated addresses 00400h to 007FFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.



Figure 3.2 Memory Map of R8C/27 Group

## 5. Electrical Characteristics

## 5.1 N, D Version

#### Table 5.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vi	Input voltage		-0.3 to Vcc + 0.3	V
Vo	Output voltage		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	Topr = 25°C	500	mW
Topr	Operating ambient temperature		-20 to 85 (N version) / -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

#### Table 5.2 Recommended Operating Conditions

Symbol	Parameter		Conditions	Standard			Unit
Symbol			Conditions	Min.	Тур.	Max.	Unit
Vcc/AVcc	Supply voltage			2.2	-	5.5	V
Vss/AVss	Supply voltage			-	0	-	V
Viн	Input "H" voltage			0.8 Vcc	-	Vcc	V
VIL	Input "L" voltage			0	-	0.2 Vcc	V
IOH(sum)	Peak sum output "H" current	Sum of all pins IOH(peak)		-	-	-160	mA
IOH(sum)	Average sum output "H" current	Sum of all pins IOH(avg)		-	_	-80	mA
IOH(peak)	Peak output "H"	Except P1_0 to P1_7		-	-	-10	mA
	current	P1_0 to P1_7		-	-	-40	mA
IOH(avg)	Average output	Except P1_0 to P1_7		-	-	-5	mA
	"H" current	P1_0 to P1_7		-	_	-20	mA
IOL(sum)	Peak sum output "L" currents	Sum of all pins IOL(peak)		-	-	160	mA
IOL(sum)	Average sum output "L" currents	Sum of all pins IOL(avg)		-	_	80	mA
IOL(peak)	Peak output "L"	Except P1_0 to P1_7		-	-	10	mA
	currents	P1_0 to P1_7		-	-	40	mA
IOL(avg)	Average output	Except P1_0 to P1_7		-	-	5	mA
	"L" current	P1_0 to P1_7		-	_	20	mA
f(XIN)	XIN clock input osc	illation frequency	$3.0 \text{ V} \leq \text{Vcc} \leq 5.5 \text{ V}$	0	-	20	MHz
			$2.7~V \leq Vcc < 3.0~V$	0	-	10	MHz
			$2.2 \text{ V} \leq \text{Vcc} < 2.7 \text{ V}$	0	-	5	MHz
f(XCIN)	XCIN clock input of	scillation frequency	$2.2 \text{ V} \leq \text{Vcc} \leq 5.5 \text{ V}$	0	-	70	kHz
-	System clock	OCD2 = 0	$3.0 \text{ V} \leq \text{Vcc} \leq 5.5 \text{ V}$	0	-	20	MHz
		XIN clock selected	$2.7~V \leq Vcc < 3.0~V$	0	-	10	MHz
			$2.2 \text{ V} \leq \text{Vcc} < 2.7 \text{ V}$	0	-	5	MHz
		OCD2 = 1 On-chip oscillator clock selected	FRA01 = 0 Low-speed on-chip oscillator clock selected	-	125	-	kHz
			$\begin{array}{l} \mbox{FRA01} = 1 \\ \mbox{High-speed on-chip} \\ \mbox{oscillator clock selected} \\ \mbox{3.0 V} \le Vcc \le 5.5 \ V \end{array}$	-	-	20	MHz
			FRA01 = 1 High-speed on-chip oscillator clock selected $2.7 \text{ V} \le \text{Vcc} \le 5.5 \text{ V}$	-	-	10	MHz
			FRA01 = 1 High-speed on-chip oscillator clock selected $2.2 \text{ V} \le \text{Vcc} \le 5.5 \text{ V}$	-	_	5	MHz

NOTES:

1. Vcc = 2.2 to 5.5 V at Topr = -20 to  $85^{\circ}$ C (N version) / -40 to  $85^{\circ}$ C (D version), unless otherwise specified.

2. The average output current indicates the average value of current measured during 100 ms.

Symbol	Parameter	Condition		Llnit		
Symbol	i arameter	Condition	Min.	Тур.	Max.	Onit
fOCO40M	High-speed on-chip oscillator frequency	Vcc = 4.75 to 5.25 V	39.2	40	40.8	MHz
	temperature • supply voltage dependence	$0^{\circ}C \leq T_{opr} \leq 60^{\circ}C^{(2)}$				
		Vcc = 3.0 to 5.5 V	38.8	40	41.2	MHz
		$-20^{\circ}C \leq T_{opr} \leq 85^{\circ}C^{(2)}$				
		Vcc = 3.0 to 5.5 V	38.4	40	41.6	MHz
		$-40^{\circ}C \leq T_{opr} \leq 85^{\circ}C^{(2)}$				
		Vcc = 2.7 to 5.5 V	38	40	42	MHz
		$-20^{\circ}C \le T_{opr} \le 85^{\circ}C^{(2)}$				
		Vcc = 2.7 to 5.5 V	37.6	40	42.4	MHz
		$-40^{\circ}C \leq T_{opr} \leq 85^{\circ}C^{(2)}$				
		Vcc = 2.2 to 5.5 V	35.2	40	44.8	MHz
		$-20^{\circ}C \le T_{opr} \le 85^{\circ}C^{(3)}$				
		Vcc = 2.2 to 5.5 V	34	40	46	MHz
		$-40^{\circ}C \le T_{opr} \le 85^{\circ}C^{(3)}$				
		$Vcc = 5.0 V \pm 10\%$	38.8	40	40.8	MHz
		$-20^{\circ}C \le T_{opr} \le 85^{\circ}C^{(2)}$				
		Vcc = 5.0 V ± 10%	38.4	40	40.8	MHz
		$-40^{\circ}C \le T_{opr} \le 85^{\circ}C^{(2)}$				
	High-speed on-chip oscillator frequency when	VCC = 5.0 V, Topr = $25^{\circ}C$	-	36.864	-	MHz
	correction value in FRA7 register is written to	Vcc = 3.0 to 5.5 V	-3%	-	3%	%
	FRA1 register <sup>(4)</sup>	$-20^{\circ}C \le T_{opr} \le 85^{\circ}C$				
-	Value in FRA1 register after reset		08h <sup>(3)</sup>	-	F7h <sup>(3)</sup>	-
-	Oscillation frequency adjustment unit of high-	Adjust FRA1 register	-	+0.3	-	MHz
	speed on-chip oscillator	(value after reset) to -1				
-	Oscillation stability time		_	10	100	μS
_	Self power consumption at oscillation	VCC = 5.0 V, Topr = $25^{\circ}C$	-	400	-	μA

Table 5.10	High-speed On-Chip Oscillator Circuit Electrical Characteristics
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NOTES:

1. Vcc = 2.2 to 5.5 V, Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

2. These standard values show when the FRA1 register value after reset is assumed.

3. These standard values show when the corrected value of the FRA6 register is written to the FRA1 register.

4. This enables the setting errors of bit rates such as 9600 bps and 38400 bps to be 0% when the serial interface is used in UART mode.

#### Table 5.11 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol Parameter		Condition		Lloit		
		Condition		Тур.	Max.	Unit
fOCO-S	Low-speed on-chip oscillator frequency		30	125	250	kHz
-	Oscillation stability time		-	10	100	μS
-	Self power consumption at oscillation	VCC = 5.0 V, Topr = 25°C	-	15	-	μA

NOTE:

1. Vcc = 2.2 to 5.5 V, Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

#### Table 5.12 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	:	Linit		
Symbol	Falanetei	Condition	Min.	Тур.	Max.	Onit
td(P-R)	Time for internal power supply stabilization during		1	-	2000	μS
	power-on <sup>(2)</sup>					
td(R-S)	STOP exit time <sup>(3)</sup>		-	-	150	μS

NOTES:

1. The measurement condition is Vcc = 2.2 to 5.5 V and  $T_{opr}$  = 25°C.

2. Waiting time until the internal power supply generation circuit stabilizes during power-on.

3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.



Symbol	Parameter		Conditions		Standard			
Symbol			Conditions	Min.	Тур.	Max.		
tsucyc	SSCK clock cycle time	)		4	=	-	tCYC <sup>(2)</sup>	
tнı	SSCK clock "H" width			0.4	-	0.6	tsucyc	
tLO	SSCK clock "L" width			0.4	-	0.6	tsucyc	
trise	SSCK clock rising	Master		-	=	1	tCYC <sup>(2)</sup>	
	time	Slave		-	-	1	μs	
<b>tFALL</b>	SSCK clock falling	Master		-	=	1	tCYC <sup>(2)</sup>	
	time	Slave		-	-	1	μs	
ts∪	SSO, SSI data input s	etup time		100	-	-	ns	
tн	SSO, SSI data input h	old time		1	-	-	tCYC <sup>(2)</sup>	
<b>t</b> LEAD	SCS setup time	Slave		1tcyc + 50	-	_	ns	
tlag	SCS hold time	Slave		1tcyc + 50	-	_	ns	
top	SSO, SSI data output delay time			-	-	1	tCYC <sup>(2)</sup>	
tSA	SSI slave access time		$2.7 \text{ V} \leq \text{Vcc} \leq 5.5 \text{ V}$	-	-	1.5tcyc + 100	ns	
			$2.2 \text{ V} \leq \text{Vcc} < 2.7 \text{ V}$	-	-	1.5tcyc + 200	ns	
tOR	SSI slave out open time		$2.7 \text{ V} \leq \text{Vcc} \leq 5.5 \text{ V}$	_	=	1.5tcyc + 100	ns	
			2.2 V ≤ Vcc < 2.7 V	_	-	1.5tcyc + 200	ns	

Table 5.13 Timing Requirements of Clock Synchronous Serial I/O with Chip Select<sup>(1)</sup>

NOTES:

1. Vcc = 2.2 to 5.5 V, Vss = 0 V at T<sub>opr</sub> = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified. 2. 1tcvc = 1/f1(s)



Symbol	ol Parameter		Condition		S	Lloit		
Symbol	Fa	ameter	Condition		Min.	Тур.	Max.	Unit
Vон	Output "H" voltage	Except P1_0 to P1_7,	Iон = -5 mA		Vcc - 2.0	-	Vcc	V
		XOUT	Іон = -200 μА		Vcc - 0.5	-	Vcc	V
		P1_0 to P1_7	Drive capacity HIGH	Іон = -20 mA	Vcc - 2.0	-	Vcc	V
			Drive capacity LOW	Iон = -5 mA	Vcc - 2.0	-	Vcc	V
		XOUT	Drive capacity HIGH	Іон = -1 mA	Vcc - 2.0	-	Vcc	V
			Drive capacity LOW	Іон = -500 μА	Vcc - 2.0	-	Vcc	V
Vol	Output "L" voltage	Except P1_0 to P1_7,	IoL = 5 mA		-	-	2.0	V
		XOUT	Ιοι = 200 μΑ		-	-	0.45	V
		P1_0 to P1_7	Drive capacity HIGH	IoL = 20 mA	-	-	2.0	V
			Drive capacity LOW	IoL = 5 mA	-	-	2.0	V
		XOUT	Drive capacity HIGH	lo∟ = 1 mA	-	-	2.0	V
			Drive capacity LOW	IoL = 500 μA	=	=	2.0	V
Vt+-Vt-	Hysteresis	INT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, CLK1, SSI, SCL, SDA, SSO			0.1	0.5	_	V
		RESET			0.1	1.0	-	V
Ін	Input "H" current		VI = 5 V, Vcc = 5 V		_	_	5.0	μA
lı∟	Input "L" current		VI = 0 V, Vcc = 5 V		-		-5.0	μA
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 5 V		30	50	167	kΩ
Rfxin	Feedback resistance	XIN			-	1.0	_	MΩ
Rfxcin	Feedback resistance	XCIN			-	18	1	MΩ
VRAM	RAM hold voltage		During stop mode		1.8	_	-	V

Table 5.15	Electrical Characteristics (1	) [Vcc = 5 V]
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NOTE:

1. Vcc = 4.2 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 20 MHz, unless otherwise specified.

#### Timing Requirements (Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C) [Vcc = 5 V]

#### Table 5.18 XIN Input, XCIN Input

Symbol	Symbol Parameter		Standard		
Symbol			Max.	Offic	
tc(XIN)	XIN input cycle time	50	-	ns	
twh(XIN)	XIN input "H" width	25	-	ns	
twl(XIN)	XIN input "L" width	25	-	ns	
tc(XCIN)	XCIN input cycle time	14	-	μS	
twh(xcin)	XCIN input "H" width	7	-	μS	
twl(xcin)	XCIN input "L" width	7	-	μS	



### Figure 5.8 XIN Input and XCIN Input Timing Diagram when Vcc = 5 V

#### Table 5.19 TRAIO Input

Symbol	vmbol Parameter		dard	Lloit
Symbol		Min.	Max.	Onit
tc(TRAIO)	TRAIO input cycle time	100	-	ns
twh(traio)	TRAIO input "H" width	40	-	ns
twl(traio)	TRAIO input "L" width	40	Ι	ns



Figure 5.9 TRAIO Input Timing Diagram when Vcc = 5 V

# Table 5.29Electrical Characteristics (6) [Vcc = 2.2 V]<br/>(Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Condition		Standard	b	Llnit
Symbol	i alametei		Condition	Min.	Тур.	Max.	Onin
Icc	Power supply current (Vcc = 2.2 to 2.7 V) Single-chip mode, output pins are open	High-speed clock mode	XIN = 5 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	3.5	_	mA
	other pins are Vss		XIN = 5 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	1.5	_	mA
		High-speed on-chip oscillator	XIN clock off High-speed on-chip oscillator on fOCO = 5 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	3.5		mA
		mode	XIN clock off High-speed on-chip oscillator on fOCO = 5 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	1.5	-	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR47 = 1	-	100	230	μΑ
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz FMR47 = 1	-	100	230	μΑ
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz Program operation on RAM Flash memory off, FMSTP = 1	-	25	_	μΑ
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	22	60	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	20	55	μA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = $32 \text{ kHz}$ (high drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	3.0	_	μΑ
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	1.8	_	μΑ
		Stop mode	XIN clock off, $T_{opr} = 25^{\circ}C$ High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	0.7	3.0	μΑ
			XIN clock off, $T_{opr} = 85^{\circ}C$ High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	1.1	_	μA

## 5.2 J, K Version

Table 5.34	Absolute	Maximum	Ratings
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Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vi	Input voltage		-0.3 to Vcc + 0.3	V
Vo	Output voltage		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	-40 °C $\leq$ Topr $\leq$ 85 °C	300	mW
		85 °C $\leq$ Topr $\leq$ 125 °C	125	mW
Topr	Operating ambient temperature		-40 to 85 (J version) / -40 to 125 (K version)	°C
Tstg	Storage temperature		-65 to 150	°C

#### Table 5.35 Recommended Operating Conditions

Symbol	Dorr	motor	Conditions		Standard		Linit
Symbol	Fala	ameter	Conditions	Min.	Тур.	Max.	Unit
Vcc/AVcc	Supply voltage			2.7	_	5.5	V
Vss/AVss	Supply voltage			-	0	-	V
Vih	Input "H" voltage			0.8 Vcc	_	Vcc	V
VIL	Input "L" voltage			0	_	0.2 Vcc	V
IOH(sum)	Peak sum output "H" current	Sum of all pins IOH(peak)		-	-	-60	mA
IOH(peak)	Peak output "H" current			-	-	-10	mA
IOH(avg)	Average output "H" current			-	-	-5	mA
IOL(sum)	Peak sum output "L" currents	Sum of all pins IOL(peak)		-	-	60	mA
IOL(peak)	Peak output "L" currents			-	-	10	mA
IOL(avg)	Average output "L" current			-	-	5	mA
f(XIN)	XIN clock input os	cillation frequency	$3.0 \text{ V} \le \text{Vcc} \le 5.5 \text{ V}$ (other than K version)	0	-	20	MHz
			$3.0 \text{ V} \leq \text{Vcc} \leq 5.5 \text{ V}$ (K version)	0	-	16	MHz
			$2.7 \text{ V} \leq \text{Vcc} < 3.0 \text{ V}$	0	_	10	MHz
_	System clock	OCD2 = 0 XIN clock selected	3.0 V $\leq$ Vcc $\leq$ 5.5 V (other than K version)	0	-	20	MHz
			$3.0 \text{ V} \leq \text{Vcc} \leq 5.5 \text{ V}$ (K version)	0	-	16	MHz
			$2.7 \text{ V} \leq \text{Vcc} < 3.0 \text{ V}$	0	_	10	MHz
		OCD2 = 1 On-chip oscillator clock selected	FRA01 = 0 Low-speed on-chip oscillator clock selected	-	125	-	kHz
			FRA01 = 1 High-speed on-chip oscillator clock selected (other than K version)	-	_	20	MHz
			FRA01 = 1 High-speed on-chip oscillator clock selected	-	-	10	MHz

NOTES:

1. Vcc = 2.7 to 5.5 V at  $T_{opr}$  = -40 to 85°C (J version) / -40 to 125°C (K version), unless otherwise specified.

2. The average output current indicates the average value of current measured during 100 ms.



Symbol	Baramatar	Condition		Standard		Linit
Symbol	Falameter	Condition	Min.	Тур.	Max.	Unit
fOCO40M	High-speed on-chip oscillator frequency	Vcc = 4.75 to 5.25 V	39.2	40	40.8	MHz
	temperature - supply voltage dependence	$0^{\circ}C \leq T_{opr} \leq 60^{\circ}C^{(2)}$				
		Vcc = 3.0 to 5.5 V	38.8	40	41.2	MHz
		$\text{-}20^\circ C \leq T_{opr} \leq 85^\circ C^{(2)}$				
		Vcc = 3.0 to 5.5 V	38.4	40	41.6	MHz
		$-40^\circ C \leq T_{opr} \leq 85^\circ C^{(2)}$				
		Vcc = 3.0 to 5.5 V	38	40	42	MHz
		$-40^\circ C \leq T_{opr} \leq 125^\circ C^{(2)}$				
		Vcc = 2.7 to 5.5 V	37.6	40	42.4	MHz
		$-40^\circ C \leq T_{opr} \leq 125^\circ C^{(2)}$				
-	Value in FRA1 register after reset		08h	-	F7h	-
-	Oscillation frequency adjustment unit of high-	Adjust FRA1 register	-	+0.3	-	MHz
	speed on-chip oscillator	(value after reset) to -1				
_	Oscillation stability time		_	10	100	μS
-	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	-	400	-	μA

Table 5.42 High-speed On-Chip Oscillator Circuit Electrical Characteristics

NOTES:

1. Vcc = 2.7 to 5.5 V, Topr = -40 to 85°C (J version) / -40 to 125°C (K version), unless otherwise specified.

2. These standard values show when the FRA1 register value after reset is assumed.

#### Table 5.43 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Lloit		
Symbol		Condition	Min.	Тур.	Max.	Unit
fOCO-S	Low-speed on-chip oscillator frequency		40	125	250	kHz
-	Oscillation stability time		-	10	100	μS
-	Self power consumption at oscillation	VCC = $5.0 \text{ V}$ , Topr = $25^{\circ}\text{C}$	-	15	-	μΑ

NOTE:

1. Vcc = 2.7 to 5.5 V, Topr = -40 to 85°C (J version) / -40 to 125°C (K version), unless otherwise specified.

#### Table 5.44 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	:	Standard	ł	Lloit
Symbol	Falanetei	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on <sup>(2)</sup>		1	-	2000	μS
td(R-S)	STOP exit time <sup>(3)</sup>		-	-	150	μS

NOTES:

1. The measurement condition is Vcc = 2.7 to 5.5 V and Topr =  $25^{\circ}$ C.

2. Waiting time until the internal power supply generation circuit stabilizes during power-on.

3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.



Figure 5.24 I/O Timing of Clock Synchronous Serial I/O with Chip Select (Slave)

Symbol	Par	amotor	Conditio	Condition		andard		Linit
Symbol	Fai	ameter	Conditio	11	Min.	Тур.	Max.	Offic
Vон	Output "H" voltage	Except XOUT	Iон = -5 mA		Vcc - 2.0	-	Vcc	V
			Іон = -200 μА		Vcc - 0.3	-	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -1 mA	Vcc - 2.0	-	Vcc	V
			Drive capacity LOW	Іон = -500 μА	Vcc - 2.0	-	Vcc	V
Vol	Output "L" voltage	Except XOUT	IoL = 5 mA		-	-	2.0	V
			Ιοι = 200 μΑ		-	-	0.45	V
		XOUT	Drive capacity HIGH	IoL = 1 mA	-	-	2.0	V
			Drive capacity LOW	Iol = 500 μA	-	-	2.0	V
Vt+-Vt-	Hysteresis	INT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, CLK1, SSI, SCL, SDA, SSO			0.1	0.5	_	V
		RESET			0.1	1.0	_	V
Ін	Input "H" current	•	VI = 5 V, Vcc = 5V		-	-	5.0	μA
lı∟	Input "L" current		VI = 0 V, Vcc = 5V		-	-	-5.0	μA
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 5V		30	50	167	kΩ
Rfxin	Feedback resistance	XIN			-	1.0	_	MΩ
VRAM	RAM hold voltage		During stop mode		2.0	_	-	V

### Table 5.47 Electrical Characteristics (1) [Vcc = 5 V]

NOTE:

1. Vcc = 4.2 to 5.5 V at Topr = -40 to 85°C (J version) / -40 to 125°C (K version), f(XIN) = 20 MHz, unless otherwise specified.

	Table	5.57	Serial	Interface
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Symbol	Deromotor		Standard		
		Min.	Max.	Offic	
tc(CK)	CLKi input cycle time	300	-	ns	
tW(CKH)	CLKi input "H" width	150	-	ns	
tW(CKL)	CLKi Input "L" width	150	-	ns	
td(C-Q)	TXDi output delay time	-	80	ns	
th(C-Q)	TXDi hold time	0	-	ns	
tsu(D-C)	RXDi input setup time	70	-	ns	
th(C-D)	RXDi input hold time	90	-	ns	

i = 0 or 1





#### Table 5.58 External Interrupt INTi (i = 0, 1, 3) Input

Symbol	Paramotor	Standard		Unit
	Falanielei		Max.	
tw(INH)	INTi input "H" width	380(1)	-	ns
tw(INL)	INTi input "L" width	380(2)	-	ns

NOTES:

1. When selecting the digital filter by the INTi input filter select bit, use an INTi input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

2. When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency x 3) or the minimum value of standard, whichever is greater.



Figure 5.34 External Interrupt INTi Input Timing Diagram when Vcc = 3 V

# **REVISION HISTORY**

# R8C/26 Group, R8C/27 Group Datasheet

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1.00	Nov 08, 2006	27	Table 5.9, Figure 5.3 revised and Table 5.10 deleted	
		28	Table 5.10, Table 5.11 revised	
		34	Table 5.15 revised	
		35	Table 5.16 revised	
		36	Table 5.17 revised	
		39	Table 5.22 revised	
		40	Table 5.23 revised	
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		1	1 "J and K versions are under developmentnotice." added 1.1 revised	
		2	Table 1.1 revised	
		3	Table 1.2 revised	
		4	Figure 1.1 NOTE3 added	
		5	Table 1.3, Figure 1.2 revised	
		6	Table 1.4, Figure 1.3 revised	
		7	Figure 1.4 NOTE3 added	
		8	Table 1.5 revised	
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		13	Figure 3.1 revised	
		14	Figure 3.2 revised	
		15	Table 4.1; "0000h to 003Fh" → "0000h to 002Fh" revised • NOTE3 added	
		16	<ul> <li>Table 4.2; "0040h to 007Fh" → "0030h to 007Fh" revised</li> <li>0032h, 0036h: "After reset" is revised</li> <li>0038h: NOTE revised</li> <li>NOTES 2, 5, 6 revised and NOTE 7, 8 added</li> </ul>	
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		6	Figure 1.2 revised	
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		26, 51	Table 5.4, Table 5.37 NOTE2, NOTE4 revised	
		27, 52	Table 5.5, Table 5.38 NOTE2, NOTE5 revised	
		53	Table 5.39 Parameter: Voltage monitor 1 reset generation time added NOTE5 added	
			Table 5.40 revised	
		54	Table 5.41 revised Figure 5.22 revised	

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